PUBLICATIONS

The conference organizers will provide a Book of Abstracts on USB including all submitted contributions. For each text one page A5 is allocated.

The poster size is A0 in portrait format (approximately 80 cm x 110 cm).

Details for the preparation of abstracts, posters and proceeding contributions, templates and instructions are available at the conference website.

SCIENTIFIC ORGANIZATION

Max-Planck-Institut für Chemische Physik fester Stoffe Prof. Juri Grin Nöthnitzer Str. 40, 01187 Dresden, Germany T. +49 (0) 351-46464608

For more details, see www.cpfs.mpg.de/ICT2015

DATES

Early registration April 7, 2015 Abstract submission April 7, 2015 Article submission May 15, 2015

The conference fee for participants amounts to 700,00 Euro before April 7th and 820,00 Euro thereafter.



CALL FOR ABSTRACTS AND PAPERS

FIRST CIRCULAR



REGISTRATION, EXHIBITION, SPONSORING

Intercom Dresden GmbH
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EXHIBITION AND SPONSORSHIP

The conference will be accompanied by an industrial exhibition. If your company is interested, please contact the congress agency concerning conditions for sponsoring.

34TH ANNUAL INTERNATIONAL CONFERENCE ON THERMOELECTRICS (ICT 2015)

AND

13TH EUROPEAN CONFERENCE ON THERMOELECTRICS (ECT 2015)

> JUNE 28TH – JULY 2ND, 2015 DRESDEN, GERMANY

SCOPE

The ICT & ECT 2015 conference is organized under the auspices of the International and European Thermoelectrics Societies and will offer an international forum for scientific exchange on thermoelectricity. The sessions will cover all aspects from materials design, synthesis and characterization to application issues and modules. Oral presentations include comprehensive contributions by invited speakers. In addition, poster sessions will give the opportunity for informal discussions on specific issues. An exhibition of relevant equipment will be offered.

TOPICS

New materials Characterization of properties Theoretical aspects Module manufacturing Application issues

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INFORMATION ABOUT DRESDEN

Dresden - also known as the Florence of the North' - has a history of more than 800 years. The city is famous for its splendid art collections, baroque architecture and exciting cultural life. More than 9.5 million visitors come to Dresden each year.

Dresden has developed a unique atmosphere, characterized formerly by its role as a royal residence and now by that of a federal-state capital. The flair of the city is based above all on its blend of architectural sights, world famous collections and living traditions in music and fine arts. Even today the buildings from the Renaissance, Baroque and 19th century decorate the banks of the Elbe and make up the face of the city.



CONFERENCE VENUE

The conference will be held in the new International Congress Center Dresden, located at the River Elbe with a spectacular view to the historical city of Dresden, and within walking distance to the historical city center with many restaurants and hotels. It operates in close cooperation with its direct neighbor, the Maritim Hotel on the premises of the old Erlwein storehouse.

Maritim Hotel & International Congress Center Dresden Ostra-Ufer 2 / Devrientstr. 10 - 12, 01067 Dresden, Germany Telefon: + 49 (0) 351 216-0 / Fax: + 49 (0) 351 216-1000 www.dresden-congresscenter.de



TRAVEL & ACCOMMODATION

Dresden can be easily reached by plane through nonstop flights from a number of German and European cities including Frankfurt, Munich, Zurich, and London, and of course also by train.

There are plenty of hotels available in all categories, and within walking distance to the conference venue. For details, please refer to the ICT & ECT 2015 webpage.

